HI1812T800R-10

PHYSICAL DIMENSIONS:

IMPEDANCE

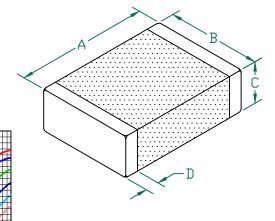
A 4.50 [.177] ± 0.25 [.010]

B 3.20 [.126] ± 0.25 [.010]

C 1.40 [.055] ± 0.25 [.010]

D 0.65 [.026] ± 0.45 [.018]

Z vs FREQUENCY
IMPEDANCE UNDER DC BIAS

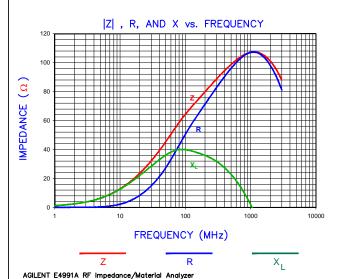


ELECTRICAL CHARACTERISTICS:											
Z @ 100MHz (Ω)		DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current								
Nominal	80										
Minimum	60										
Maximum	100	0.010	6000 mA								

NOTES: UNLESS OTHERWISE SPECIFIED

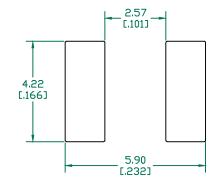
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2500 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATEING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)

FREQUENCY (MHz)



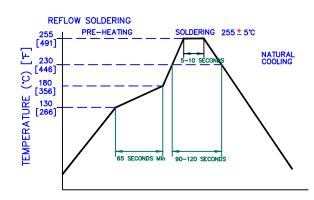
HP 16194A Test Fixture. TEST REF. 3298

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS





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	DIMENSIONS ARE IN mm [INCHES].			This print is the property of Laird					
				Tech, and is loaned in confidence			_		. ■"
				subject to return upon request with the understanding that no	1	2	ir(
				copies shall be made without th	▮┗	a	II (
				written consent of Laird Tech. A rights to design or invention are		_			
				reserved.					
D ADD	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	PROJECT/PART NUMBER:	П	REV	PART TO	PE:	DRAWN BY:
	UPDATE LAIRD LOGO AND REFLOW CURVE			HI1812T800R-10		D	CO-FIRE		ТМВ
L C	UPDATE D DIMENSION	03/12/10	JUN	1111012100011 10		0	l		'
В	UPDATE COMPANY LOGO ADD ROHS	01/24/08	JRK	DATE: 04/02/04	SCA	NIS		SHEET:	
Α	ORIGINAL DRAFT	04/02/04	ТМВ	CAD 4	TOO			1	of 1
REV	DESCRIPTION	DATE	INT	"HI1812T800R-10-D			-		01 1